

APFA3010SURKCGKSYKC

3.0 x 1.0 mm Right Angle SMD Chip LED Lamp

DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Super Bright Yellow device is made with AlGaInP (on GaAs substrate) light emitting diode chip
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 3.0 x 1.5 x 1.0 mm right angle SMD LED, 1.0 mm thickness
- · Low power consumption
- · Wide viewing angle
- · Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- · Halogen-free
- · Tinned pads for improved solderability
- RoHS compliant

APPLICATIONS

- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

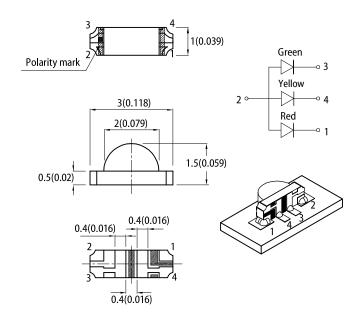
SELECTION GUIDE

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

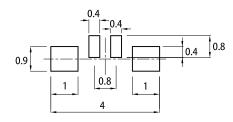


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: ± 0.1)



- . All dimensions are in millimeters (inches). . Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
- The device has a single mounting surface. The device must be mounted according to the specifications.

 For right angle SMD LEDs, the solder stencil should be at least 5mil in thickness, to prevent poor solder wetting due to insufficient solder paste.

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA [2]		Viewing Angle [1]
			Min.	Тур.	201/2
APFA3010SURKCGKSYKC	■ Hyper Red (AlGaInP)	Water Clear	120	220	
			*55	*80	
	Green (AlGalnP)		20	45	4500
			*20	*45	150°
	Super Bright Yellow (AlGalnP)		120	180	
			*120	*180	

Notes.

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

* Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	O mark at	Furthern Oaks	Value		Unit
Parameter	Symbol	Emitting Color	Тур. Мах.		
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Hyper Red Green Super Bright Yellow	645 574 590	-	nm
Dominant Wavelength I _F = 20mA	λ _{dom} ^[1]	Hyper Red Green Super Bright Yellow	630 570 590	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Hyper Red Green Super Bright Yellow	28 20 20	-	nm
Capacitance	С	Hyper Red Green Super Bright Yellow	35 15 20	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Hyper Red Green Super Bright Yellow	1.95 2.1 2	2.5 2.5 2.5	V
Reverse Current (V _R = 5V)	I _R	Hyper Red Green Super Bright Yellow	-	10 10 10	μA
Temperature Coefficient of λ_{peak} I_F = 20mA, -10°C $\leq T \leq 85^{\circ}C$	ТС _{дреак}	Hyper Red Green Super Bright Yellow	0.14 0.12 0.12	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 20mA, -10°C \leq T \leq 85°C	TC_{\lambdadom}	Hyper Red Green Super Bright Yellow	0.05 0.08 0.07	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C \leq T \leq 85°C	TC _V	Hyper Red Green Super Bright Yellow	-1.9 -1.9 -1.9	-	mV/°C

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

	Symbol	Value			
Parameter		Hyper Red	Green	Super Bright Yellow	Unit
Power Dissipation	P _D	75	75	75	mW
Reverse Voltage	V _R	5	5	5	V
Junction Temperature	T _j	115	115	115	°C
Operating Temperature	T _{op}		°C		
Storage Temperature T _{stg} -40 to +85				°C	
DC Forward Current	l _F	30	30	30	mA
Peak Forward Current	I _{FM} ^[1]	185	150	175	mA
Electrostatic Discharge Threshold (HBM)	-	3000	3000	3000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} [2]	610	710	790	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} [2]	500	600	680	°C/W

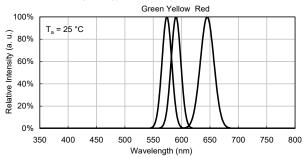
^{1.} The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd: ±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. $R_{\text{th},M}$, $R_{\text{th},E}$ Results from mounting on PC board FR4 (pad size \geq 16 mm² per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

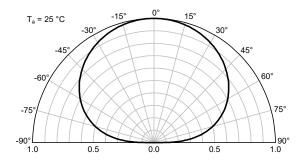


TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH

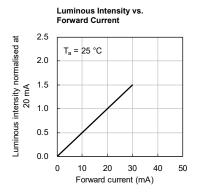


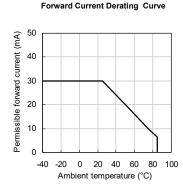
SPATIAL DISTRIBUTION

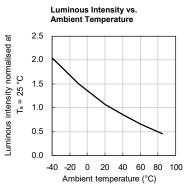


HYPER RED

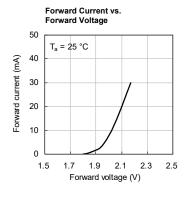
Forward Current vs. Forward Voltage 50 T_a = 25 °C Forward current (mA) 30 20 10 0 1.5 2.1 2.3 Forward voltage (V)

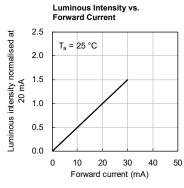


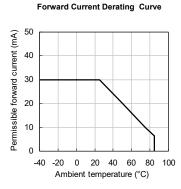


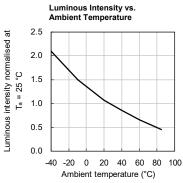


GREEN

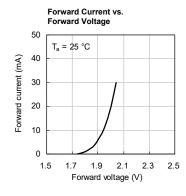


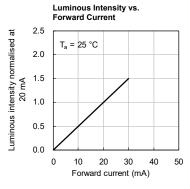


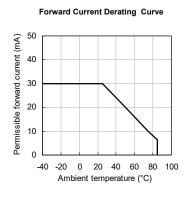


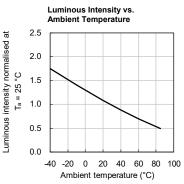


SUPER BRIGHT YELLOW



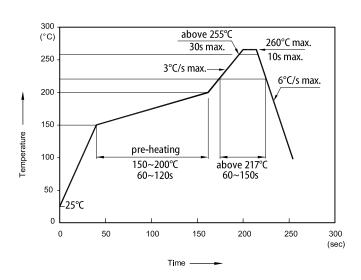






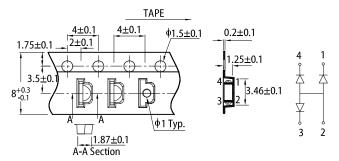


REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

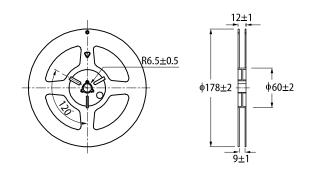


- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

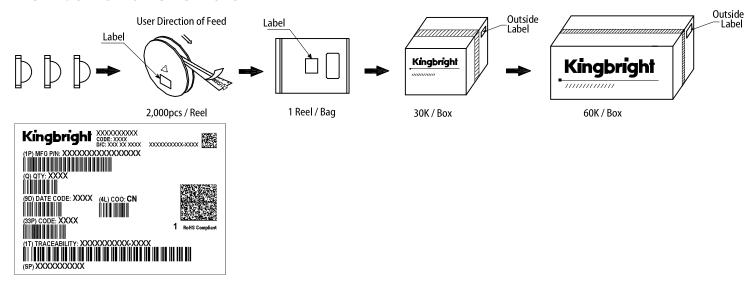
TAPE SPECIFICATIONS (units:mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
- liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.

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